

100V 2.2mohm N-channel SGT MOSFET
AKG10N022DAM-A

Description:

This N channel SGT MOSFET has been designed to low on-state resistance and maintain superior switching performance, especially for high efficiency power management applications. AEC-Q101 Qualified

Features:

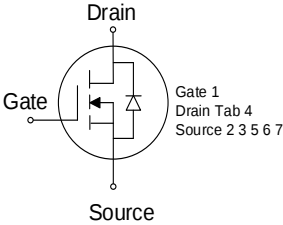
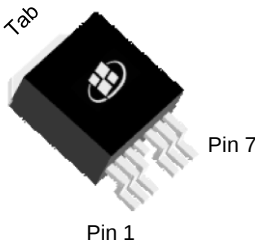
- Low $R_{DS(ON)}$
- RoHS compliant
- Halogen-free
- 100% UIS tested
- AEC-Q101 Qualified

Applications:

- Power Management Switches
- DC-DC Converter
- Battery Management System

Key Performance Parameters:

Parameter	Value	Unit
V_{DS}	100	V
$R_{DS(ON)}$, max @ $V_{GS} = 10\text{ V}$	2.2	m Ω
I_D	240	A



Ordering Information:

Ordering Code	Package Type	Marking Code	Form	Packing
AKG10N022DAM-A	TO-263-7L	G10N022DAM	Tape Reel	1000 per reel



Maximum Ratings (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Value	Units
V _{DS}	Drain-Source Voltage	100	V
I _D	Drain Current - Continuous (T _C = 25°C) ^(Note 1)	266	A
	Drain Current - Continuous (T _C = 25°C) ^(Note 2)	240	A
	Drain Current - Continuous (T _C = 100°C)	188	A
I _{DM}	Drain Current - Pulsed ^(Note 3)	960	A
V _{GS}	Gate-Source Voltage	± 20	V
E _{AS}	Single Pulsed Avalanche Energy ^(Note 4)	702	mJ
P _D	Power Dissipation (T _C = 25°C)	333	W
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +175	°C

Thermal Characteristics

Symbol	Parameter	Value	Units
R _{θJC}	Thermal Resistance, Junction-to-Case, Steady-State	0.45	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient, Steady State ^(Note 5)	50	°C/W

Notes:

- 1. The max drain current rating is silicon limited
- 2. The max drain current rating is package limited
- 3. Repetitive Rating: Pulse width limited by maximum junction temperature
- 4. L = 0.5 mH, V_{DD} = 50 V, I_{AS} = 53 A, R_g = 50 Ω, Starting T_J = 25 °C
- 5. Mount on minimum PCB layout

Electrical Characteristics (T _J = 25°C unless otherwise noted)						
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Static Characteristics						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 1 mA	100			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 100 V, V _{GS} = 0 V,			1	μA
I _{GSS}	Gate Leakage Current	V _{GS} = ± 20 V, V _{DS} = 0 V			±100	nA
V _{GS(th)}	Gate Threshold voltage	V _{DS} = V _{GS} , I _D = 250 μA	2	2.8	4	V
R _{DS(ON)}	Drain-Source on-state resistance	V _{GS} = 10 V, I _D = 100 A		1.6	2.2	mΩ
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz		11445		pF
C _{oss}	Output Capacitance			2045		pF
C _{rss}	Reverse Transfer Capacitance			70		pF
R _g	Gate Resistance	f = 1 MHz		1.5		Ω
Switching Characteristics						
t _{d(on)}	Turn On Delay Time	V _{DD} = 50 V , R _L = 0.5 Ω, V _{GS} = 10 V, R _G = 6.8 Ω		47		ns
t _r	Rise Time			93		ns
t _{d(off)}	Turn Off Delay Time			110		ns
t _f	Fall Time			140		ns
Q _g	Total Gate Charge	V _{DD} = 50 V , I _D = 100 A, V _{GS} = 10 V		155		nC
Q _{gs}	Gate-Source Charge			48		nC
Q _{gd}	Gate-Drain Charge			30		nC
Drain-Source Diode Characteristics and Maximum Ratings						
I _S	Maximum Continuous Body-Diode Forward Current				240	A
I _{SM}	Maximum Pulsed Body-Diode Forward Current				960	A
V _{SD}	Diode Forward Voltage	V _{GS} = 0 V, I _S = 100 A		0.85		V
t _{rr}	Reverse recovery time	V _{DD} = 50 V, I _D = 50 A, di/dt = 100 A/μs		95		ns
Q _{rr}	Reverse recovery charge			280		nC
I _{rrm}	Peak Reverse Recovery Current			5		A



Electrical Characteristics Diagrams

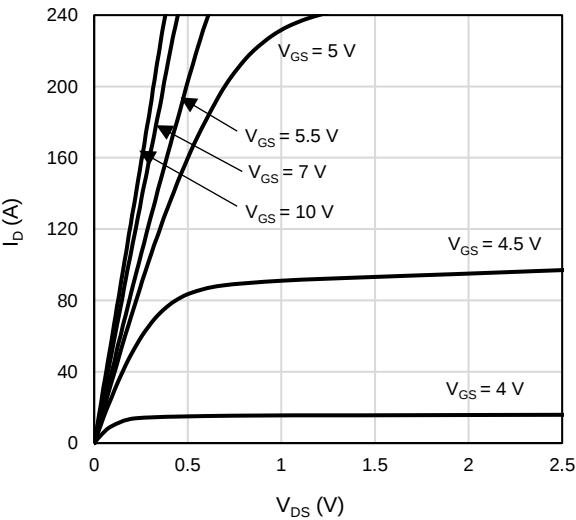


Figure 1: On-Region Characteristics

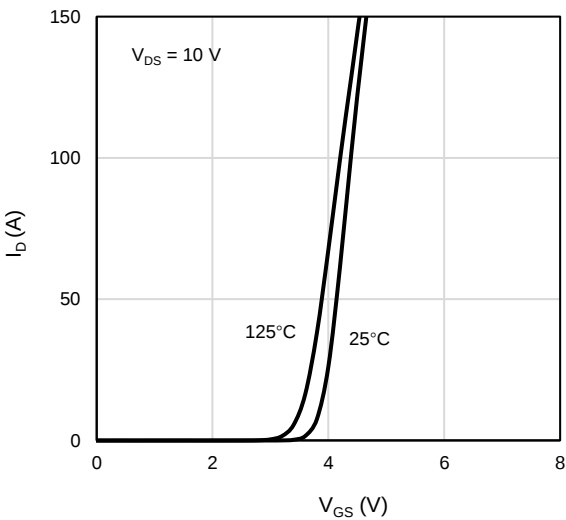


Figure 2: Transfer Characteristics

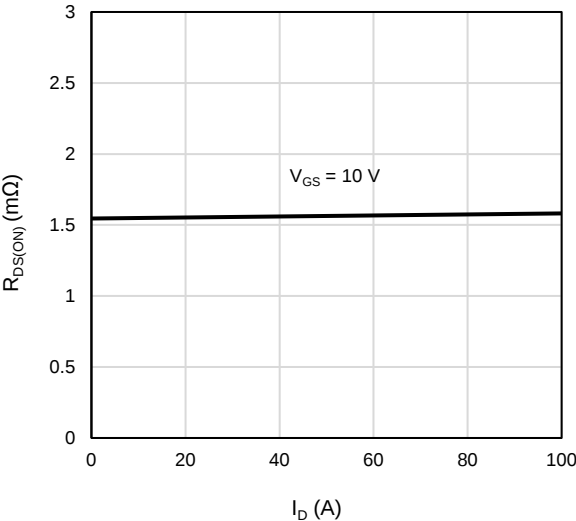


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

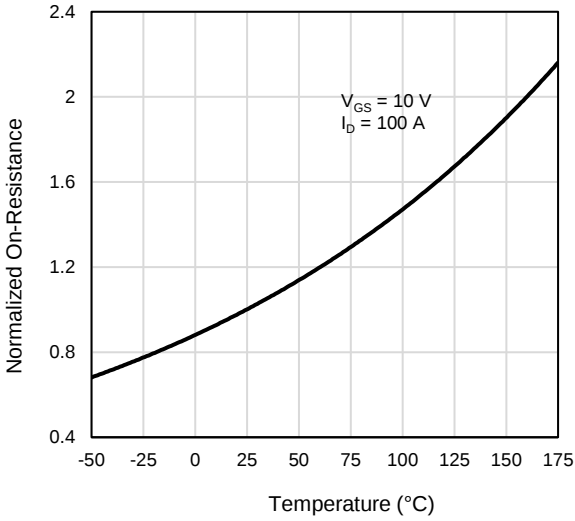


Figure 4: On-Resistance vs. Junction Temperature

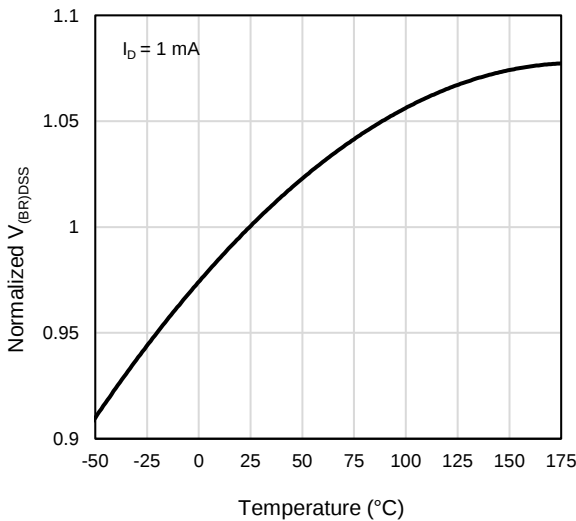


Figure 5: Breakdown Voltage vs. Junction Temperature

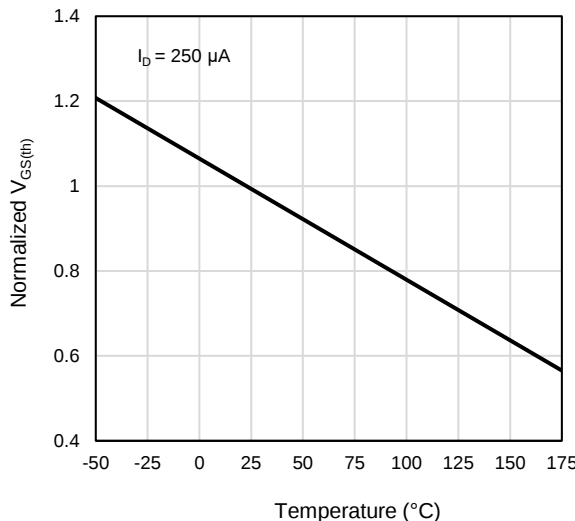


Figure 6: Threshold Voltage vs. Junction Temperature

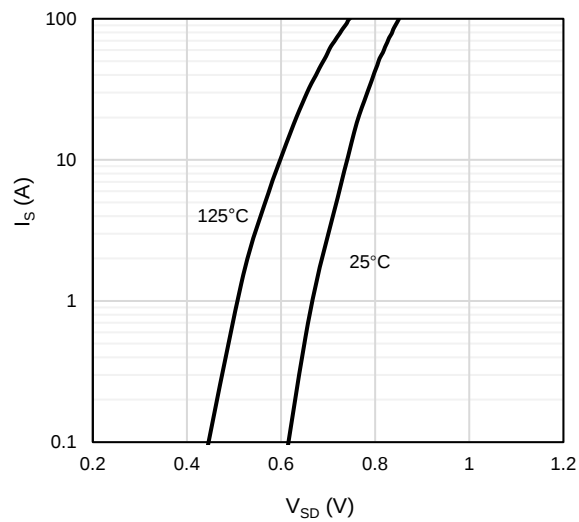


Figure 7: Body-Diode Characteristics

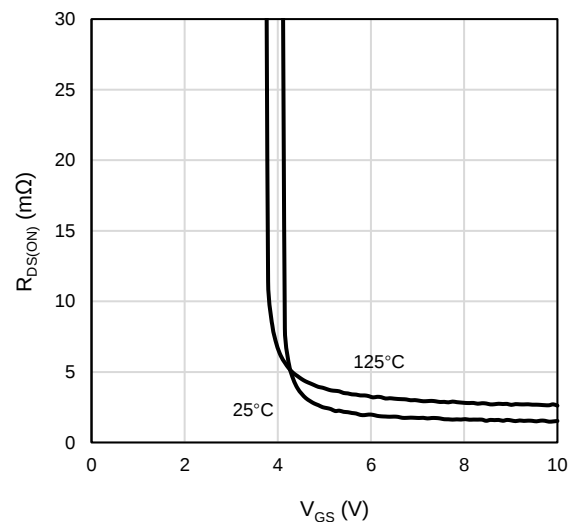


Figure 8: On-Resistance vs. Gate-Source Voltage

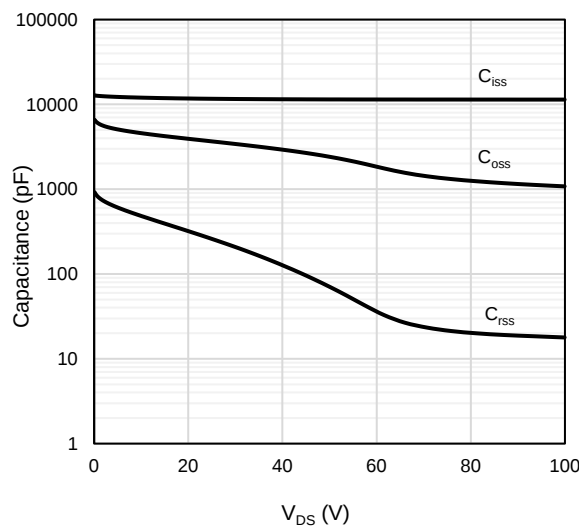


Figure 9: Capacitance Characteristics

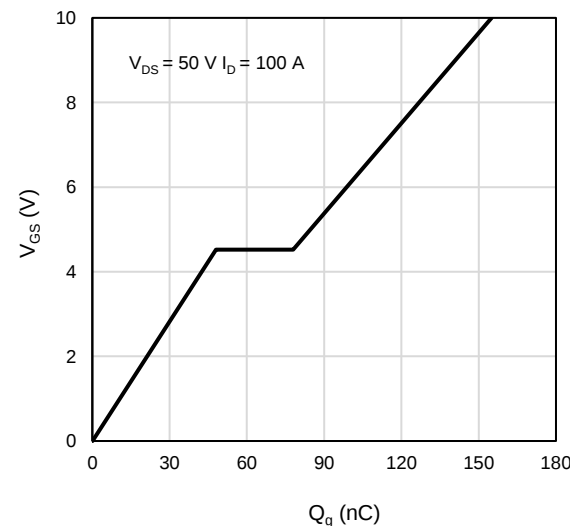


Figure 10: Gate-Charge Characteristics

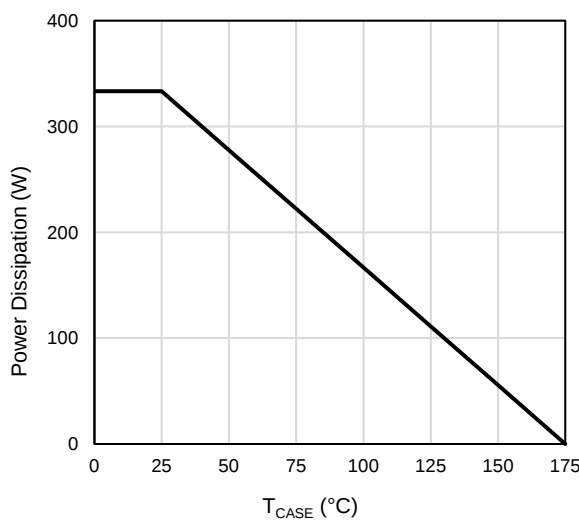


Figure 11: Power De-rating

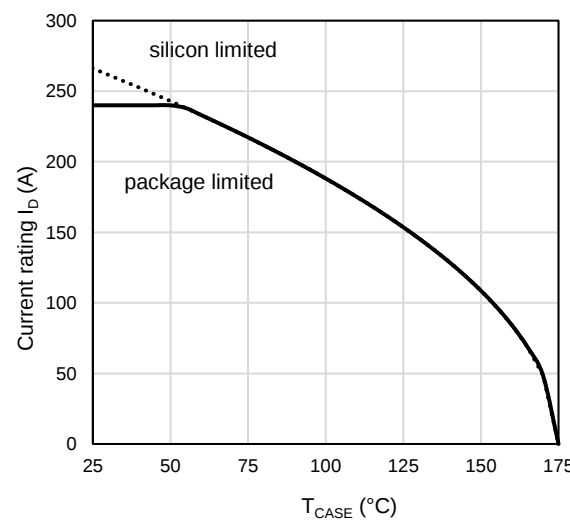


Figure 12: Current De-rating

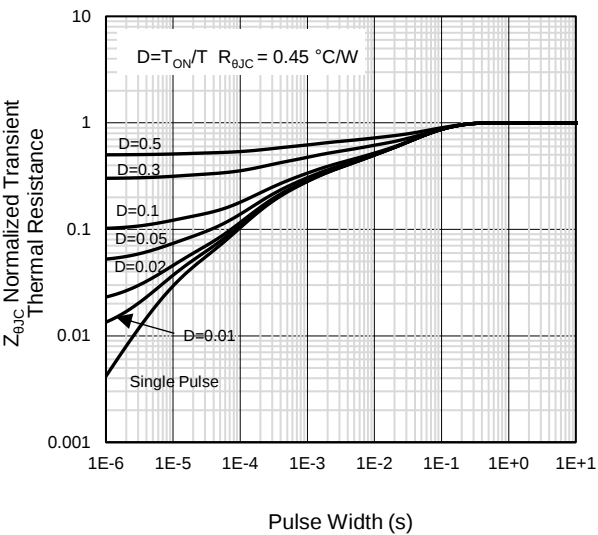


Figure 13: Normalized Maximum Transient Thermal Impedance

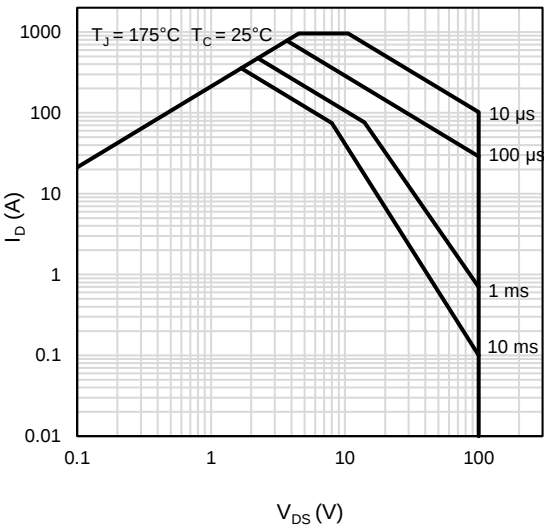
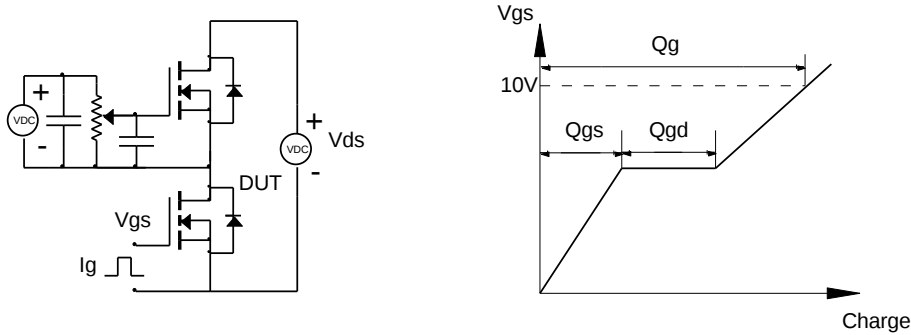


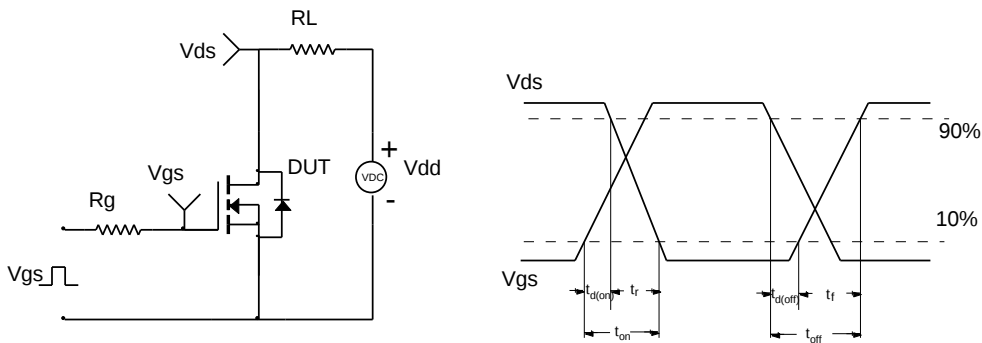
Figure 14: Maximum Forward Biased Safe Operating Area

Test Circuit and Waveform

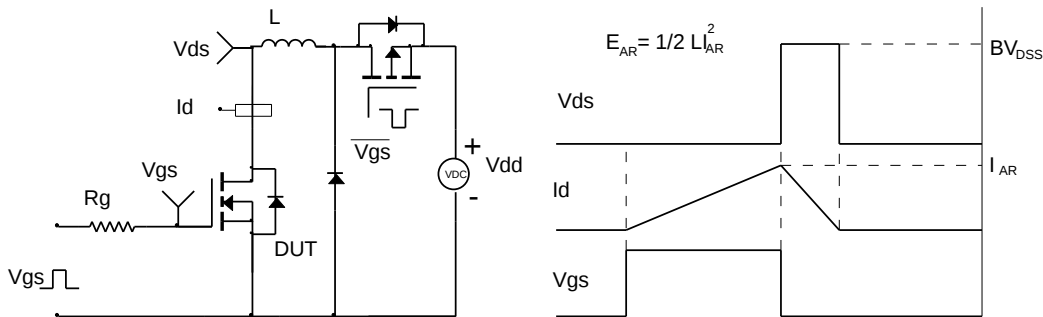
Gate Charge Test Circuit & Waveform



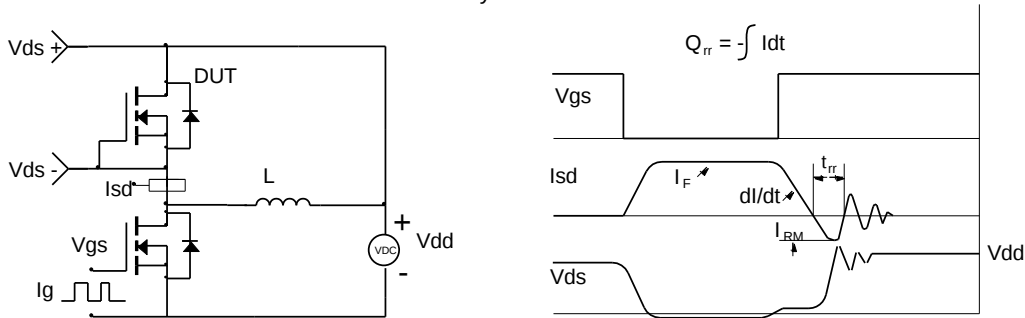
Resistive Switching Test Circuit & Waveforms



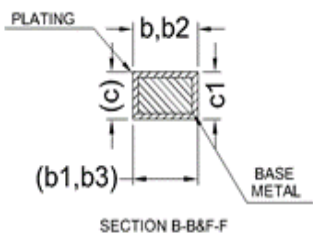
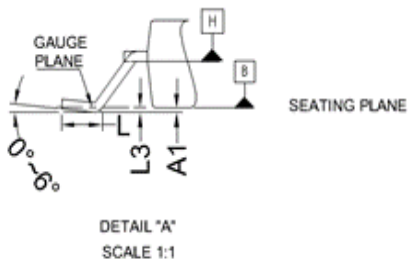
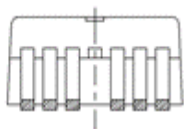
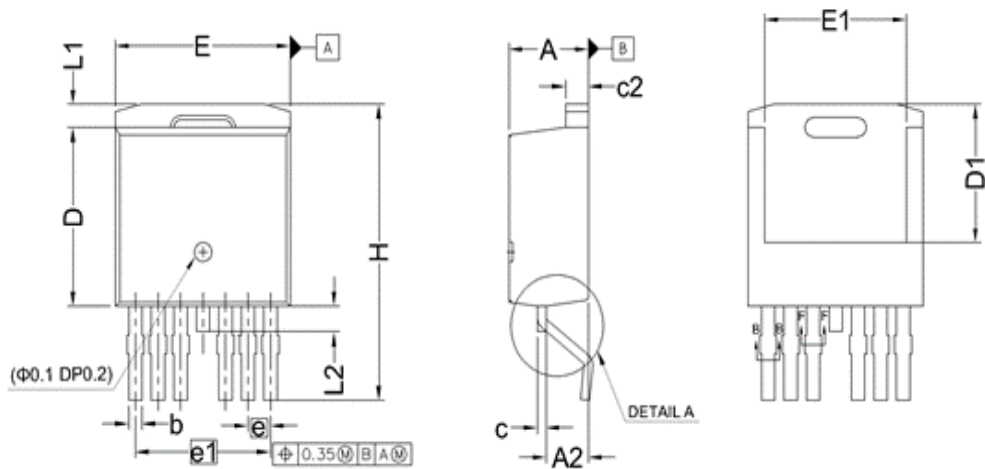
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



Package Outlines



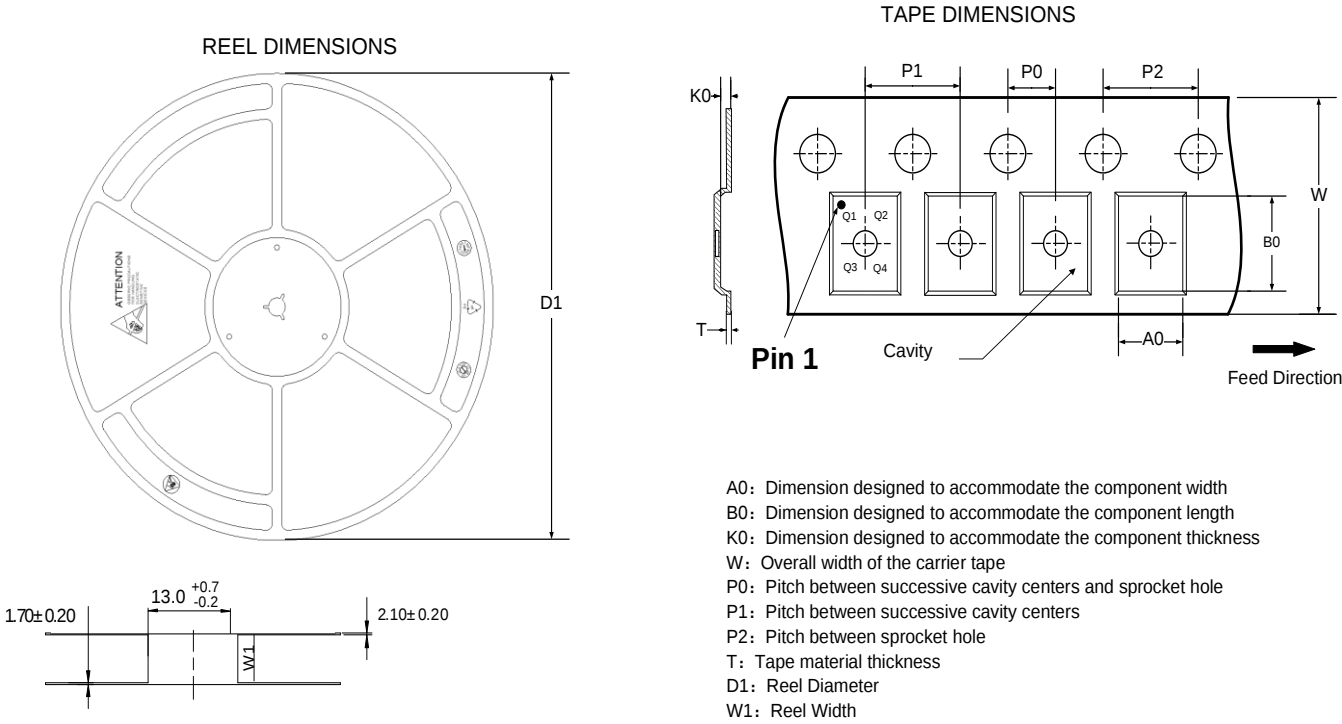
SIMBOL	MIN	MAX
A	4.30	4.70
A1	-	0.25
A2	2.20	2.60
b	0.65	0.85
b1	0.65	0.80
b2	0.80	1.00
b3	0.80	0.95
c	0.45	0.60
c1	0.45	0.55
c2	1.25	1.40
D	9.00	9.40
D1	6.86	7.42
E	9.68	10.08
E1	7.70	8.30
e	1.27 BSC	
e1	7.62 BSC	
L	1.78	2.79
L1	-	1.60
L2	-	1.78
L3	0.25 BSC	
H	14.61	15.88

Marking Information



Note:
G10N022DAM = Product Name Code
XXXXXXX = Date code
Contact ALKAIDSEMI sales for detail information

Tape & Reel Information



DIMENSIONS(Unit:mm)										
Reel	D1	W1								Material
	330	12.4								Hips
Tape	P0	P1	P2	W	A0	B0	K0	T	Pin 1 Quadrant	Material
	2	12	4	24	10.5	16.2	5.1	0.35	Q1	PC



Revision History

Revision	Released	Remark
Rev.1.0	2024	Initial Release

Disclaimer

The information given in this document describes the independent performance of the product, but similar performance is not guaranteed under other working conditions, and cannot be guaranteed when installed with other products or equipment. To achieve the required performance of the product in actual scenarios, the customer should conduct a complete application test to assess the functionality of the product.

Alkaidsemi assumes no responsibility for equipment failures result from using products at values that exceed the ratings, operating conditions, or other parameters listed in the product specifications.

The product described in this specification is not applicable for aerospace or other applications which requires high reliability. Customers using or selling these products for use in medical, life-saving, or life-sustaining applications do so at their own risk and agree to fully indemnify.

Due to product or technical improvements, the information described or contained herein may be changed without prior notice.